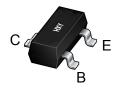


FEATURES

Collector Current: I_C=0.1A

• Power Dissipation of 200mw

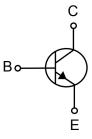


Package Marking and Ordering Information

Product ID	Pack	Qty(PCS)
2SC3356	SOT-23	3000

Marking				
50-100	80-160	125-250		
R23	R24	R25		





MAXIMUM RATINGS (Ta=25 unless otherwise noted)

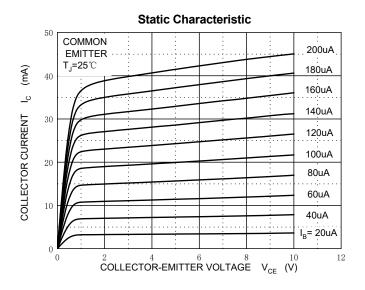
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V _{CBO}	20	V
Collector-Emitter Voltage	V _{CEO}	12	V
Emitter-Base Voltage	V _{EBO}	3	V
Collector Current	I _c	100	mA
Collector Power Dissipation	P _c	200	mW
Thermal Resistance From Junction To Ambient	R _{OJA}	625	°CM
Junction Temperature	T _j	150	°C
Storage Temperature	T _{stg}	-55∼+150	℃

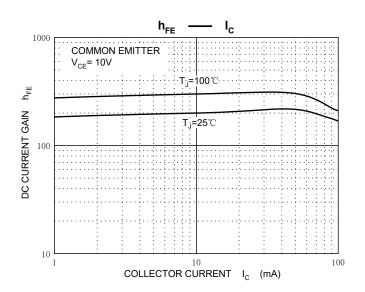


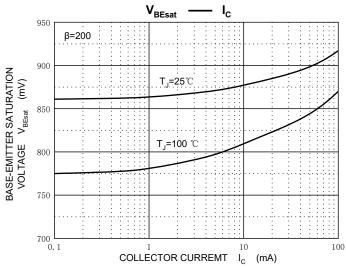
ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

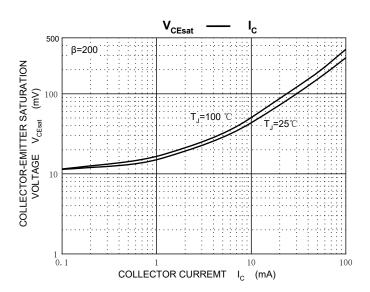
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =100μA, I _E =0	20			V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =1mA, I _B =0	12			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =100μA, I _C =0	3			V
Collector cut-off current	I _{CBO}	V _{CB} =10V, I _E =0			1	uA
Emitter cut-off current	I _{EBO}	V _{EB} =1V, I _C =0			1	uA
DC current gain	h _{FE(1)}	V _{CE} =10V, I _C =20mA	50		250	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C =50mA, I _B =5mA			0.3	V
Base-emitter saturation voltage	V _{BE(sat)}	I _C =50mA, I _B =5mA			1.15	V
Transition frequency	f _T	V _{CE} =10V,I _C =20mA		7		GHz
Collector output capacitance	C _{ob}	V _{CB} =10V, I _E =0, f=1MHz		0.8	1	pF
Noise Figure	N _F	V _{CB} =10V, I _C =7mA, f=1GHz		1.65	2	dB

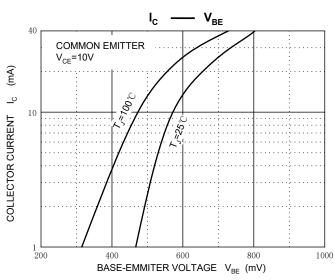
Typical Characteristics

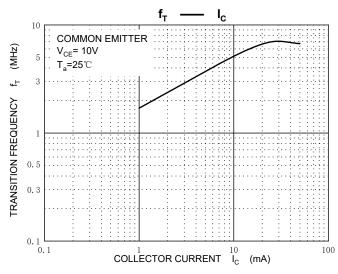


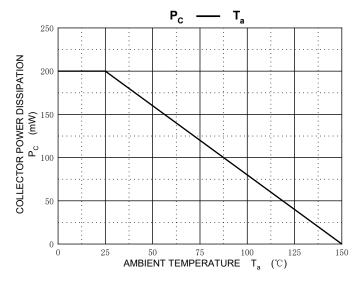






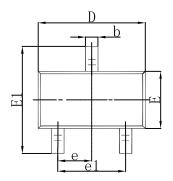


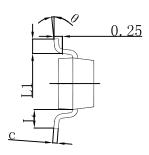


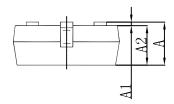




SOT-23 Package Outline Dimensions

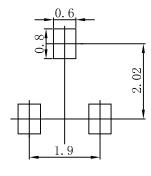






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
Ĺ	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



- Note: 1.Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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